



Low Quiescent Current, Dual-Channel Supervisory Circuit

FEATURES

- Two Supply Monitors in One Package
- One Monitor with Fixed High-Accuracy Thresholds for System Supply Monitoring
- Second Monitor with Variable Threshold and 30mV Hysteresis to Provide Failsafe
- Very Low Quiescent Current: 3.5µA typ
- High Threshold Accuracy: 1% max (0°C to +85°C)
- Open-Drain Reset Outputs
- Temperature Range: –40°C to +85°C
- Ultra-Small SC70-5 Package

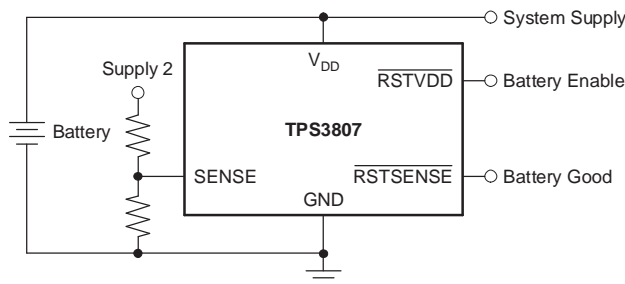
APPLICATIONS

- DSP, Microcontroller, or Microprocessor Applications Requiring User-Selected Delay Times
- Notebook/Desktop Computers
- PDAs and SmartPhones
- Other Hand-Held Products
- Portable, Battery-Powered Products
- FPGA/ASIC Applications

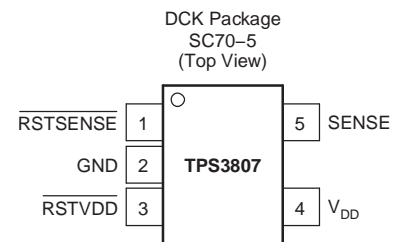
DESCRIPTION

The TPS3807 family microprocessor supervisory circuits monitor system voltages as low as 1.225V. These devices assert an open-drain $\overline{\text{RSTVDD}}$ signal when the V_{DD} voltage drops below a preset threshold. The $\overline{\text{RSTVDD}}$ output remains asserted until the V_{DD} voltage returns above its threshold. The device also provides an additional $\overline{\text{RSTSENSE}}$ output for a SENSE input with adjustable thresholds and hysteresis.

The TPS3807 uses a precision reference to achieve 1% threshold accuracy. The TPS3807 has a very low typical quiescent current of 3.5µA, so it is well-suited to battery-powered applications. It is available in a small SC70-5 package, which is half the size of a SOT-23 package, and is fully specified over a temperature range of –40°C to +85°C.



Typical Application Circuit



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION⁽¹⁾

PRODUCT	V _{DD} NEGATIVE THRESHOLD VOLTAGE (V _{DD IT-}) ⁽²⁾	V _{DD} POSITIVE THRESHOLD VOLTAGE (V _{DD IT+}) ⁽²⁾	SENSE THRESHOLD VOLTAGE (V _{SENSE IT})
TPS3807A30DCKT ⁽³⁾	3.00V	3.58V	1.225V
TPS3807A30DCKR ⁽⁴⁾	3.00V	3.58V	1.225V

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document or see the TI web site at www.ti.com.
- (2) Other voltage options are available upon request; minimum order quantities may apply.
- (3) DCKT passive indicates tape and reel containing 250 parts.
- (4) The DCKR passive indicates tape and reel containing 3000 parts.

ABSOLUTE MAXIMUM RATINGS

Over operating free-air temperature range, unless otherwise noted.⁽¹⁾

SENSE pin voltage ⁽²⁾	-0.3V to +5V
\overline{MR}	-0.3V to V _{DD} +0.3V
RESET	-0.3V to V _{DD} +0.3V
All other pins ⁽²⁾	-0.3V to +7V
Maximum output current	±5mA
Input clamp current, I _{IK} (V _{SENSE} < 0 or V _{SENSE} > V _{DD})	±10mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{DD})	±10mA
Continuous total power dissipation	See <i>Dissipation Ratings</i> table
Junction temperature, T _C	-40°C to +125°C
Storage temperature range, T _{STG}	-65°C to +150°C
Soldering temperature	+260°C
ESD rating:	
Human body model (HBM)	2kV
Charged device model (CDM)	500V

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to GND. For reliable operation, the device must not be continuously operated at 7V for more than t = 1000 hours.

DISSIPATION RATINGS

PACKAGE	θ _{JA}	DERATING FACTOR ABOVE T _A = +25°C	T _A < +25°C POWER RATING	T _A = +70°C POWER RATING	T _A = +80°C POWER RATING
DCK	+246°C/W	2.6mW/°C	406mW	223mW	167mW

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
Supply voltage, V _{DD}		1.8	6.5	V
Input voltage, V _{SENSE}	0V ≤ V _{DD} ≤ 4.2V	0	V _{DD} + 0.3	V
	V _{DD} ≥ 4.2V		4.5	
Operating free-air temperature range, T _A		-40°C	+85°C	°C

ELECTRICAL CHARACTERISTICS

Over recommended operating temperature range, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{DD}	Input supply range		1.8		6.5	V
I _{DD}	Supply current	V _{DD} = 3.3V RSTVDD, RSTSENSE = open		3.5	6.5	μA
		V _{DD} = 6.5V RSTVDD, RSTSENSE = open		4.5	7.5	μA
V _{OL}	Low-level output voltage	V _{DD} = 1.3V, I _{OL} = 0.4mA			0.3	V
		V _{DD} = 1.8V, I _{OL} = 1mA			0.4	
		V _{DD} = 3.3V, I _{OL} = 2mA			0.4	
	Power-up reset ⁽¹⁾	V _{RSTVDD} (max) = 0.2V, I _{OL} = 30μA, +25°C	0.9			V
V _{DD IT-}	Negative-going input threshold voltage ⁽²⁾		2.963	3.000	3.037	V
V _{DD IT+}	Positive-going input threshold voltage ⁽²⁾		3.530	3.575	3.620	V
V _{SENSE IT-}	Negative-going input threshold voltage	0°C to +85°C	1.213	1.225	1.237	V
		-40°C to +85°C	1.210	1.225	1.240	
V _{HYS}	SENSE input hysteresis			30		mV
I _{SENSE}	Input current		-25		+25	nA
C _I	Input capacitance	V _I = 0V to V _{DD}		1		pF
I _{OH}	High-level output current	V _{RSTVDD} , RSTSENSE = 6.5V			300	nA

(1) The lowest supply voltage at which RSTVDD (V_{RSTVDD} (max) = 0.2V, I_{OL} = 30μA) becomes active. t_{r, VDD} ≥ 15μs/V.

(2) To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1μF) should be placed near the V_{DD} pin.

TIMING REQUIREMENTS

At T_A = -40°C to +85°C, R_L = 1MΩ, and C_L = 50pF, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _W	Pulse width	V _{IH} = 1.05V _{IT} , V _{IL} = 0.95V _{IT}	10			μs

SWITCHING CHARACTERISTICS

At T_A = -40°C to +85°C, R_L = 1MΩ, and C_L = 50pF, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PHL}	Propagation delay time, high-to-low-level output	V _{DD} to RSTVDD	V _{IH} = 1.05V _{IT} , V _{IL} = 0.95V _{IT}	20		μs
		SENSE to RSTSENSE				

FUNCTIONAL BLOCK DIAGRAM

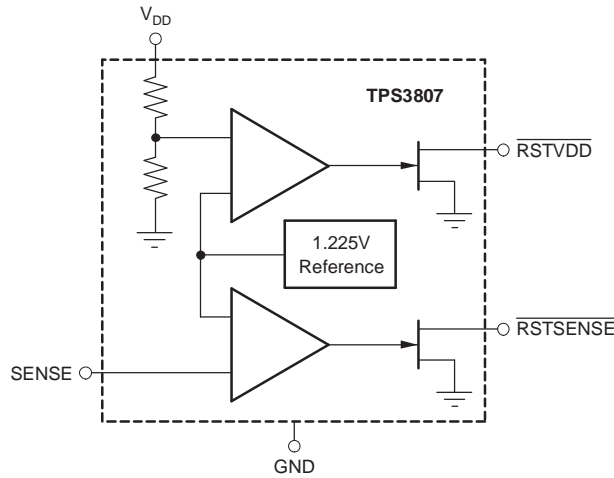


Table 1. PIN DESCRIPTIONS

NAME	PIN NO.	I/O	DESCRIPTION
RSTSENSE	1	O	RSTSENSE is an open-drain output that is driven to a low-impedance state when the SENSE input is lower than the threshold voltage $V_{SENSE\ IT-}$. RSTSENSE will remain low until SENSE is above $V_{SENSE\ IT+}$. A pull-up resistor from 10kΩ to 1MΩ should be used on this pin, and allows the reset pin to attain voltages higher than V_{DD} .
GND	2	I	Ground
RSTVDD	3	O	RSTVDD is an open-drain output that is driven to a low-impedance state when the V_{DD} input is lower than the threshold voltage $V_{DD\ IT-}$. RSTVDD will remain low until V_{DD} is above $V_{DD\ IT+}$. A pull-up resistor from 10kΩ to 1MΩ should be used on this pin, and allows the reset pin to attain voltages higher than V_{DD} .
V_{DD}	4	I	Supply voltage for the device and sense input for fixed-threshold RSTVDD outputs. A 0.1μF ceramic capacitor should be placed close to this pin for best V_{IT} stability.
SENSE	5	I	Sense input for the adjustable-threshold RSTSENSE outputs. A resistor divider from the sense voltage can be attached to this pin to set the thresholds to the desired voltages. A 0.1μF ceramic capacitor should be placed close to this pin for best V_{IT} stability.

TIMING DIAGRAM

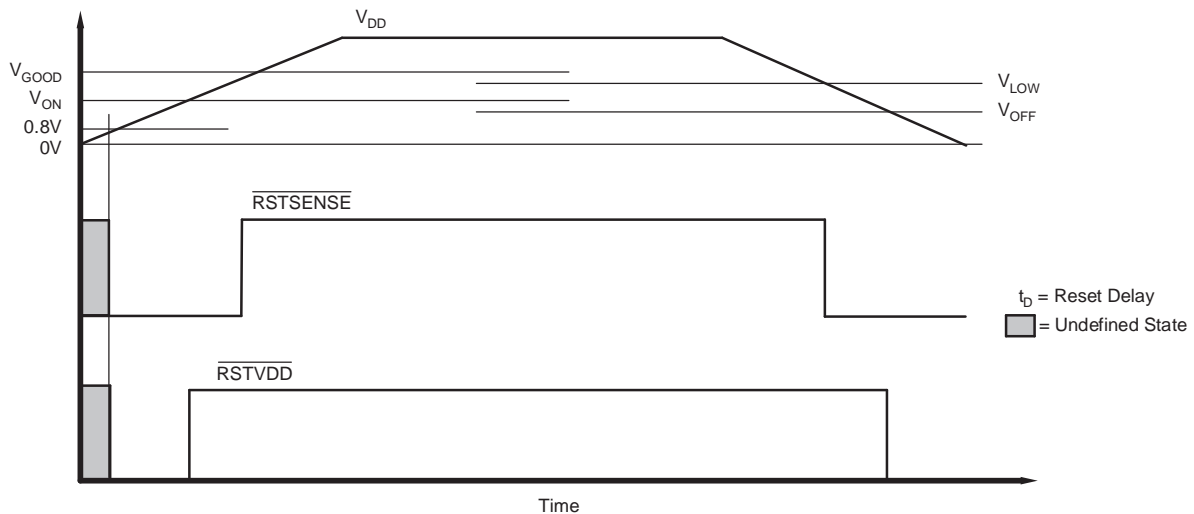


Figure 1. TPS3807 Timing Diagram Showing Reset Timing (SENSE resistor divider set to 3.6V)

TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_{DD} = 3.3\text{V}$, $R_{LRESET} = 1\text{M}\Omega$, and $C_{LRESET} = 50\text{pF}$, unless otherwise noted.

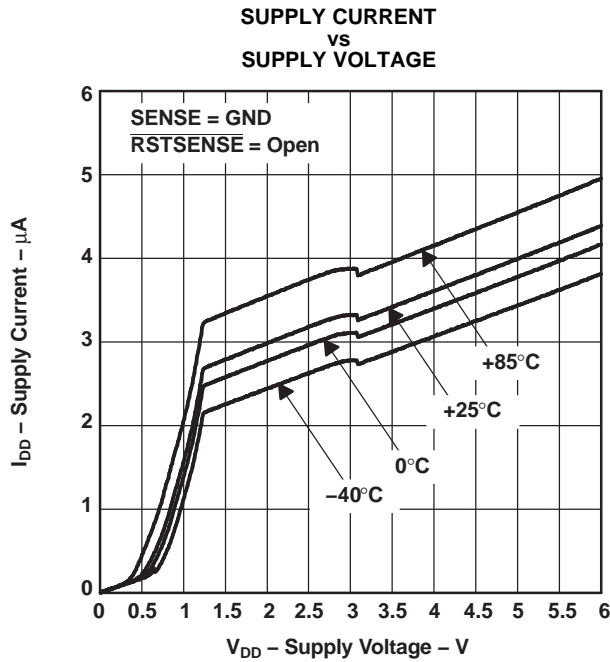


Figure 2.

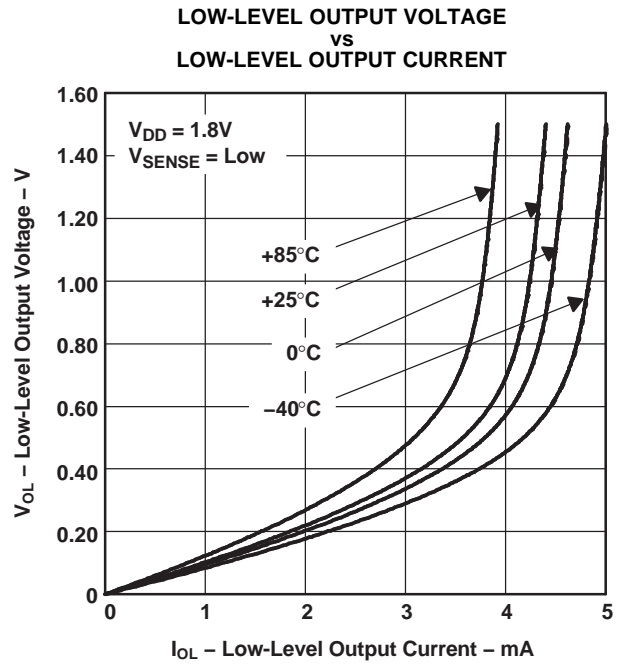


Figure 3.

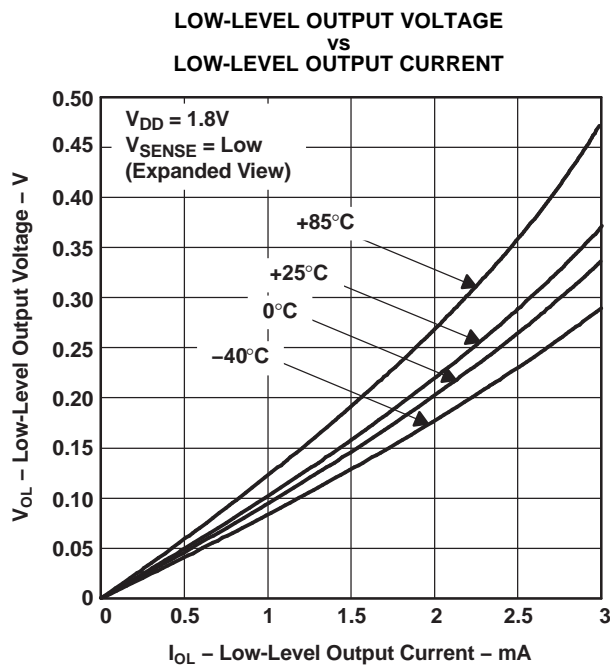


Figure 4.

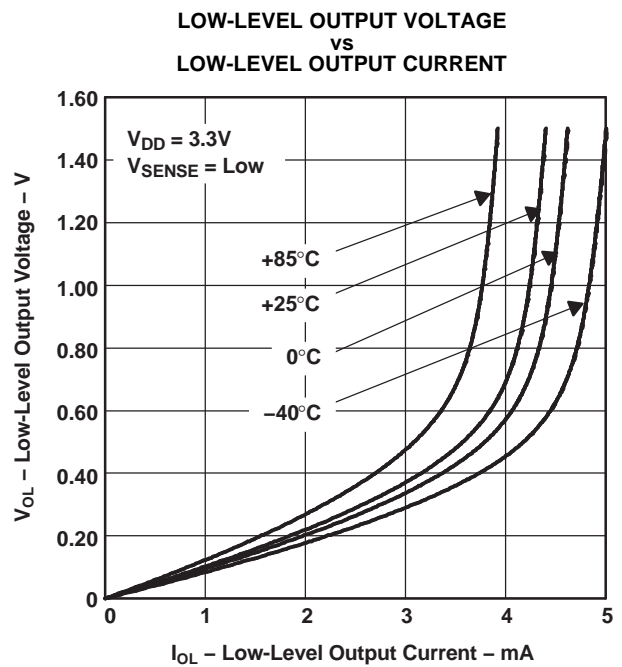
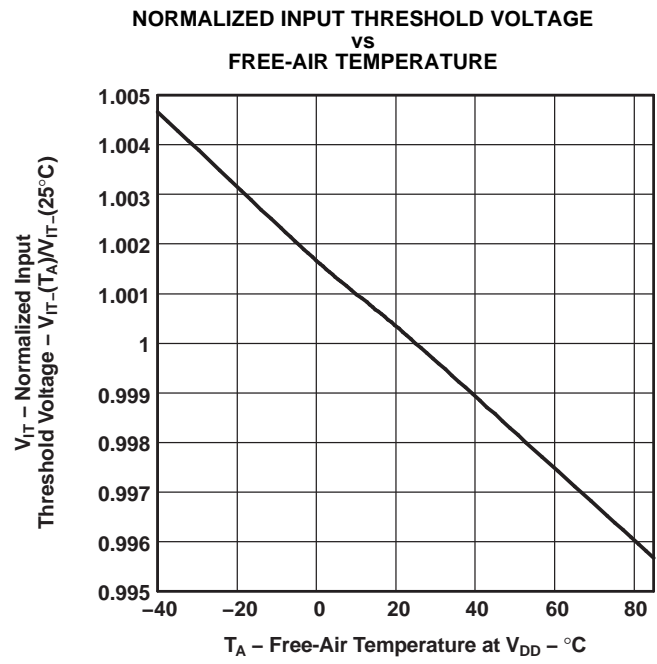
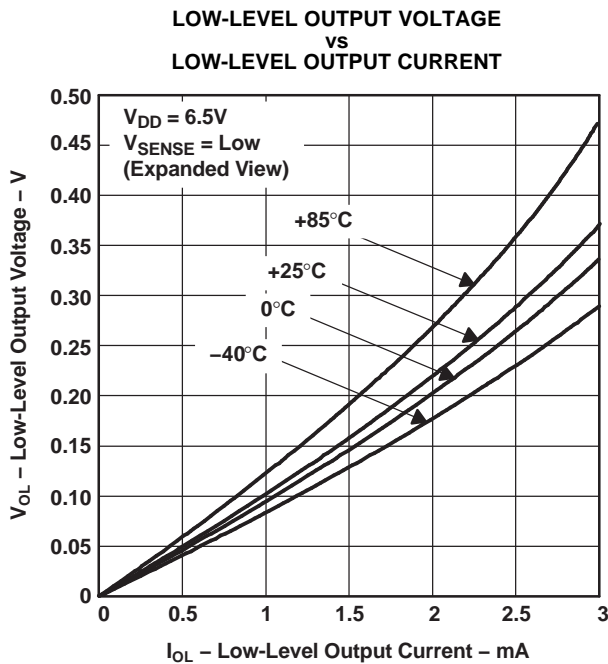
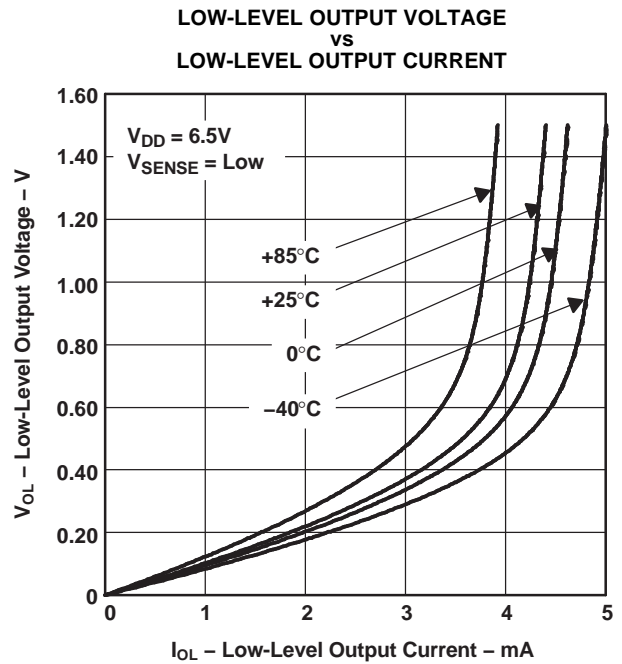
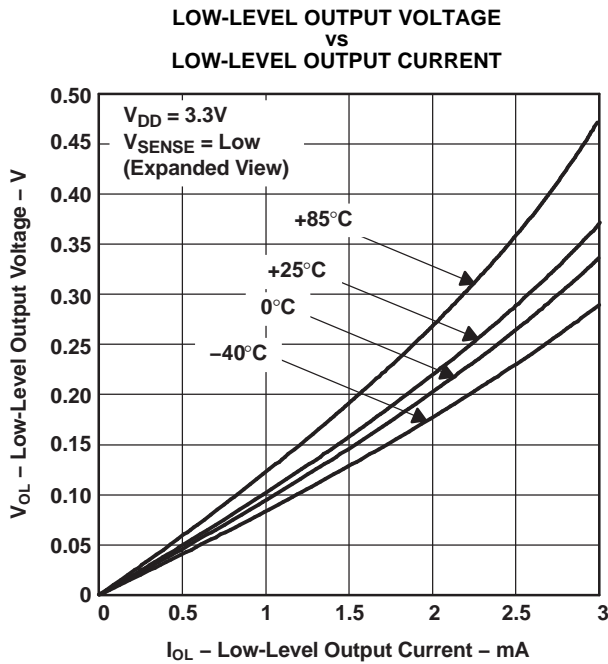


Figure 5.

TYPICAL CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_{DD} = 3.3\text{V}$, $R_{LRESET} = 1\text{M}\Omega$, and $C_{LRESET} = 50\text{pF}$, unless otherwise noted.



TYPICAL CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_{DD} = 3.3\text{V}$, $R_{LRESET} = 1\text{M}\Omega$, and $C_{LRESET} = 50\text{pF}$, unless otherwise noted.

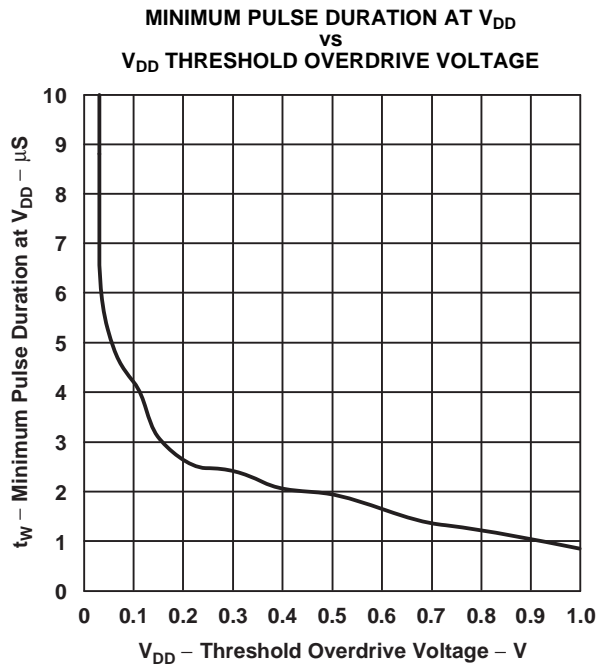


Figure 10.

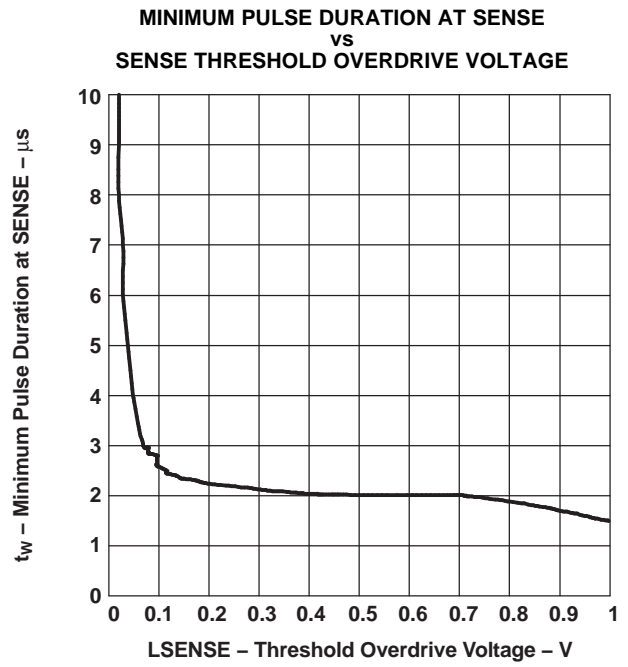


Figure 11.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TPS3807A30DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS3807A30DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS3807A30DCKT	ACTIVE	SC70	DCK	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS3807A30DCKTG4	ACTIVE	SC70	DCK	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3807A30DCKR	SC70	DCK	5	3000	180.0	9.2	2.24	1.22	2.34	4.0	8.0	Q3
TPS3807A30DCKT	SC70	DCK	5	250	180.0	9.2	2.24	1.22	2.34	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS

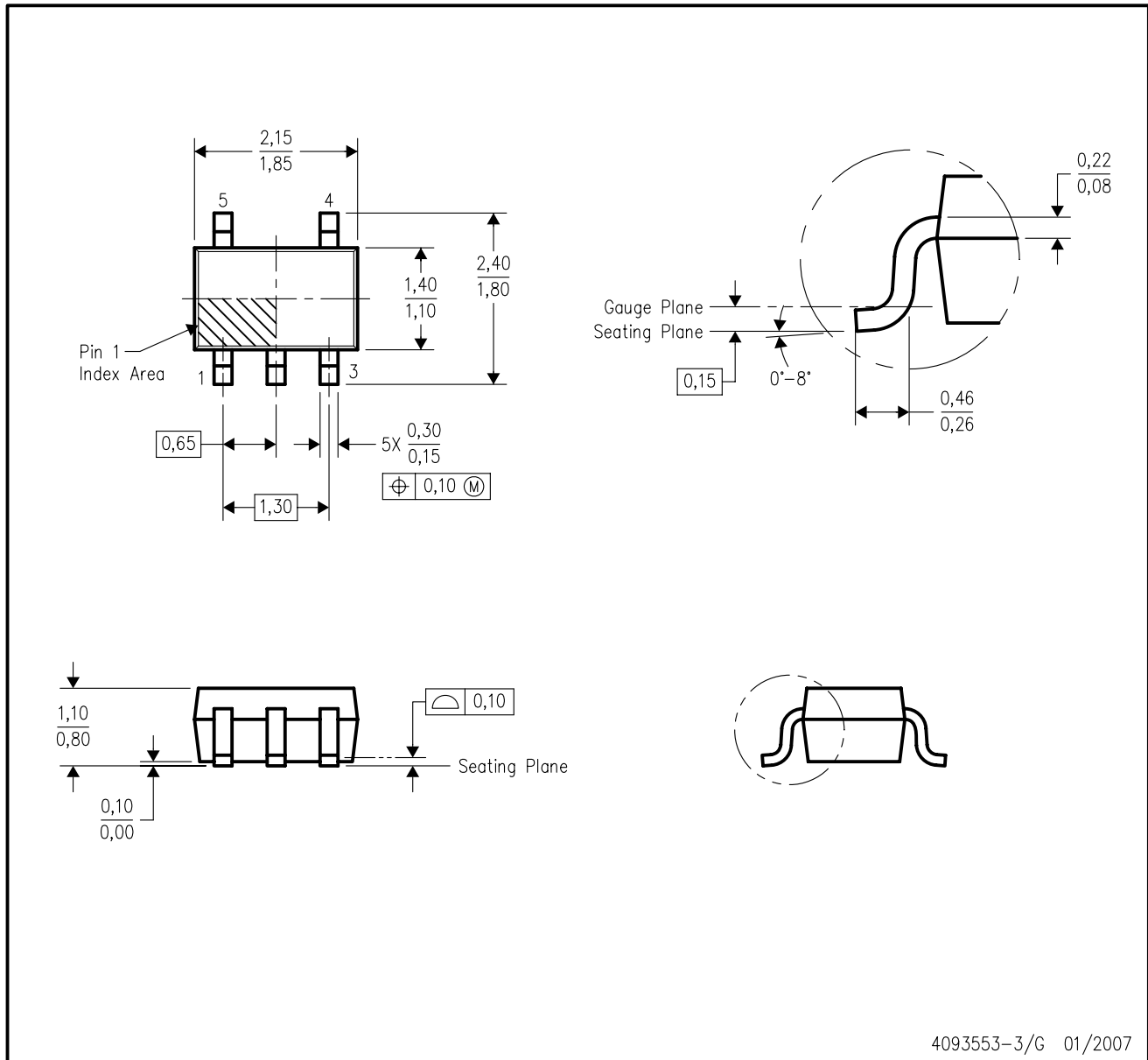


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS3807A30DCKR	SC70	DCK	5	3000	180.0	180.0	85.0
TPS3807A30DCKT	SC70	DCK	5	250	180.0	180.0	85.0

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-203 variation AA.

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